



# Product Change Notification

## 112748 - 00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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# Product Change Notification

**Change Notification #:** 112748 - 00  
**Change Title:** Intel® BD82C6XX & BD82x79 Express Chipsets, PCN 112748-00 Label, Country of Origin addition  
**Date of Publication:** November 25, 2013

**Key Characteristics of the Change:**  
 Label

**Forecasted Key Milestones:**

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Dec 26, 2013
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**Description of Change to the Customer:**

In order to ensure a continuous supply of the Intel® BD82C6XX & BD82x79 Express Chipsets listed in the "Products Affected" Table below, Intel will now manufacture these products using another Intel qualified assembly site. The new site is located in China. The new manufacturing site has been certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

Due to this change, the "ASSEMBLED IN Country" on the Intermediate Box Label will now include China. See label example below:

(P) CUST PROD: (1B) BOX: RLX00025

(V) SUPPLIER: 04195 INTEL

(1P) IPN: BD82X79

(S) SPEC: S L J N 7 (30P) MM#: 920099

(1T) LOT: FPO NUMBER (Q) QTY: 1000 (9D) DATE: YYWW

(1T) LOT: (Q) QTY: (9D) DATE:

MAX REFLOW 260 °C  
 TEMP  
 LEVEL 3 HOURS 168  
 BAG SEAL DATE 21NOV13

ASSEMBLED IN CHINA

The above label is a representation for example purposes only. The actual label will reflect correct product data.

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers for this change. Customers may see products from all assembly sites. Customers may want to notify their receiving department of the additional country listed on the label.

## Products Affected / Intel Ordering Codes:

Marketing Name	Stepping	Product Code	S-Spec	MM#
Intel® BD82C602 Platform Controller Hub	C1	BD82C602	S LJK9	919051
Intel® BD82C608 Platform Controller Hub	C1	BD82C608	S LJKF	919597
Intel® BD82C602 Platform Controller Hub	C1	BD82C602	S LJKG	919598
Intel® BD82C606 Platform Controller Hub	C1	BD82C606	S LJKH	919599
Intel® BD82C604 Platform Controller Hub	C1	BD82C604	S LJKJ	919601
Intel® BD82X79 Platform Controller Hub	C1	BD82X79	S LJN7	920099
Intel® BD82C602J Platform Controller Hub	C1	BD82C602J	S LJNG	920240

## PCN Revision History:

**Date of Revision:**

November 25, 2013

**Revision Number:**

00

**Reason:**

Originally Published PCN